

**IN THE SPECIFICATION:**

Please replace the first paragraph on page 21 with the following rewritten paragraph:

-- Referring to FIG. 6, high-dielectric constant of polymer capacitor pastes [[103a]] 105a and [[103b]] 105b are coated on both sides of an inner layer of a printed circuit board (PCB), and are semi-dried to a state of B-stage, thereby fabricating the PCB with embedded capacitors having high capacitance. --

Please replace the last paragraph on page 21 with the following rewritten paragraph:

-- As such, the capacitor pastes [[103a]] 105a and [[103b]] 105b are in the mixed composite from of BaTiO<sub>3</sub> ceramic powders having high-dielectric constant (DK: 1,000-10,000) with a thermosetting epoxy resin or polyimide, and it is possible to realize high capacitance. As for the capacitor pastes [[103a]] 105a and [[103b]] 105b, BaTiO<sub>3</sub> powders ~~comprises~~ comprise not a unimodal powder size but a bimodal powder size. Powders having 0.9 μm in diameter are mixed with powders having 60 nm in diameter at a ratio of 3:1 - 5:1, and the mixed powders are uniformly disposed into the epoxy resin, to afford a polymer ceramic composite having a dielectric constant of 80 - 90.--